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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



GP1A58HR

OPIC Photointerrupter

■ Features

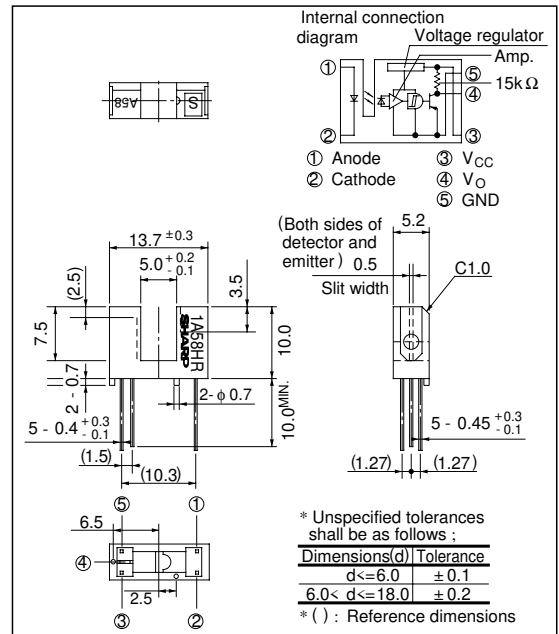
1. High sensing accuracy (Slit width: 0.5mm)
2. PWB mounting type

■ Applications

1. OA equipment such as printers, facsimiles, etc.
2. VCRs

■ Outline Dimensions

(Unit : mm)



“OPIC” (Optical IC) is a trademark of the SHARP Corporation.
An OPIC consists of a light-detecting element and signal-processing circuit integrated onto a single chip.

■ Absolute Maximum Ratings

(T_a = 25°C)

| Parameter | | Symbol | Rating | Unit |
|--------------------------|-------------------------|------------------|---------------|------|
| Input | Forward current | I _F | 50 | mA |
| | *1 Peak forward current | I _{FM} | 1 | A |
| | Reverse voltage | V _R | 6 | V |
| | Power dissipation | P | 75 | mW |
| Output | Supply voltage | V _{CC} | - 0.5 to + 17 | mA |
| | Output current | I _O | 50 | mA |
| | Power dissipation | P _O | 250 | mW |
| Operating temperature | | T _{opr} | - 25 to + 85 | °C |
| Storage temperature | | T _{stg} | - 40 to + 100 | °C |
| *2 Soldering temperature | | T _{sol} | 260 | °C |

*1 Pulse width ≤ 100 μ s, Duty ratio = 0.01

*2 For 5 seconds

Electro-optical Characteristics

(Ta = 25°C)

| Parameter | | Symbol | Conditions | MIN. | TYP. | MAX. | Unit | |
|---------------|---------------------------|---------------------------------------|--|---|------|------|---------------|---------------|
| Input | Forward voltage | V_F | $I_F = 8\text{mA}$ | - | 1.14 | 1.4 | V | |
| | Reverse current | I_R | $V_R = 3\text{V}$ | - | - | 10.0 | μA | |
| Output | Operating supply voltage | V_{CC} | - | 4.5 | - | 17.0 | V | |
| | Low level output voltage | V_{OL} | $V_{CC} = 5\text{V}, I_F = 0\text{mA}, I_{OL} = 16\text{mA}$ | - | 0.15 | 0.4 | V | |
| | High level output voltage | V_{OH} | $V_{CC} = 5\text{V}, I_F = 8\text{mA}$ | 4.9 | - | - | V | |
| | Low level supply current | I_{CCL} | $V_{CC} = 5\text{V}, I_F = 0\text{mA}$ | - | 1.7 | 3.8 | mA | |
| | High level supply current | I_{CCH} | $V_{CC} = 5\text{V}, I_F = 8\text{mA}$ | - | 0.7 | 2.2 | mA | |
| | Transfer characteristics | *1 "Low→High" threshold input current | I_{FLH} | $V_{CC} = 5\text{V}$ | - | 1.5 | 8.0 | mA |
| *2 Hysteresis | | I_{FHL} / I_{FLH} | $V_{CC} = 5\text{V}$ | 0.55 | 0.75 | 0.95 | - | |
| Response time | | "Low→High" propagation delay time | t_{PLH} | $V_{CE} = 5\text{V}, I_F = 8\text{mA}$ $R_L = 280\Omega$ | - | 3.0 | 9.0 | μs |
| | | "High→Low" propagation delay time | t_{PHL} | | - | 5.0 | 15.0 | μs |
| | | Rise time | t_r | | - | 0.1 | 0.5 | μs |
| | Fall time | t_f | - | | 0.05 | 0.5 | μs | |

*1 I_{FLH} represents forward current when output changes from low to high.*2 I_{FHL} represents forward current when output changes from high to low.

Recommended Operating Conditions

| Parameter | Symbol | Operating temperature range | MIN. | MAX. | Unit |
|-----------------|--------|---|------|------|------|
| Output current | I_O | $T_a = 0 \text{ to } +70^\circ\text{C}$ | - | 16.0 | mA |
| Forward current | I_F | | 10.0 | 20.0 | mA |

Fig. 1 Forward Current vs. Ambient Temperature

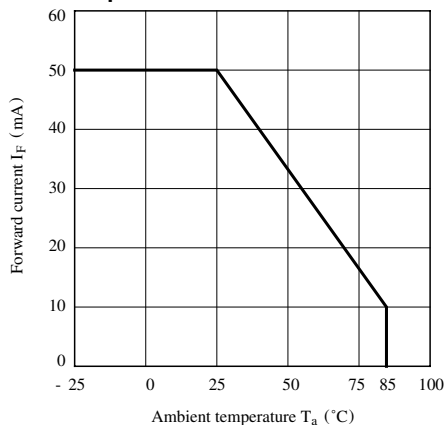


Fig. 2 Output Power Dissipation vs. Ambient Temperature

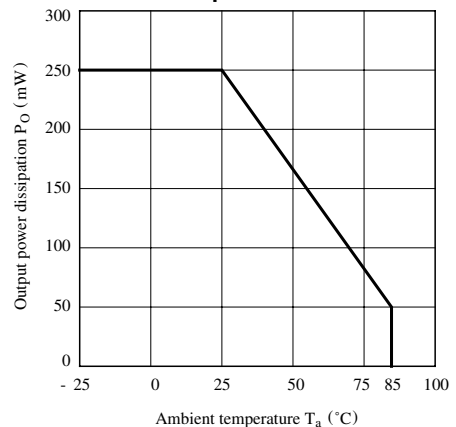


Fig. 3 Low Level Output Current vs. Ambient Temperature

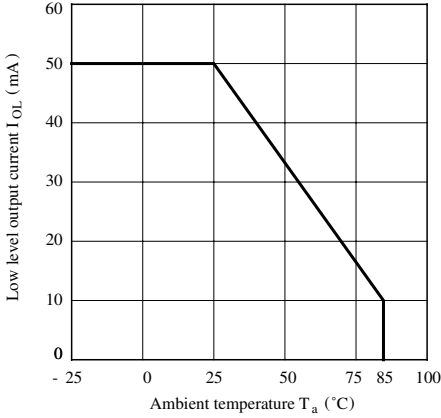


Fig. 4 Forward Current vs. Forward Voltage

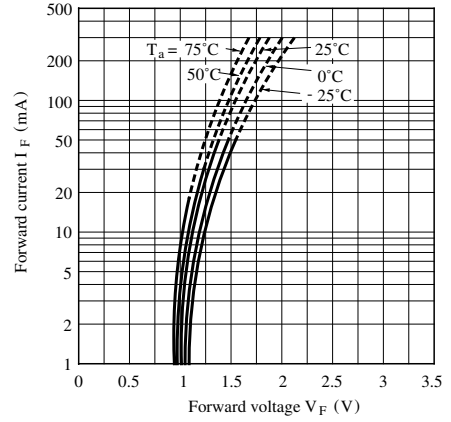


Fig. 5 Relative Threshold Input Current vs. Supply Voltage

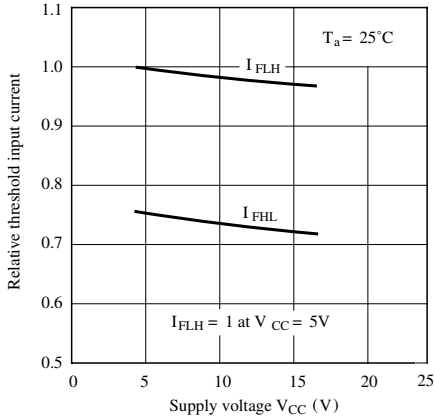


Fig. 6 Relative Threshold Input Current vs. Ambient Temperature

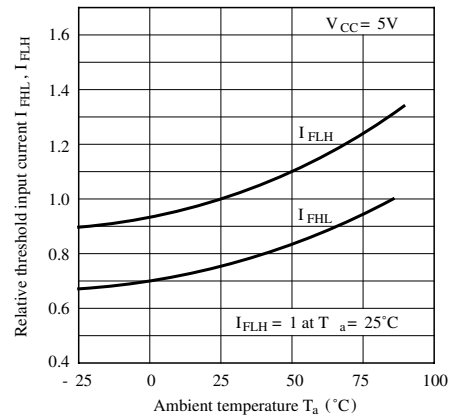


Fig. 7 Low Level Output Voltage vs. Low Level Output Current

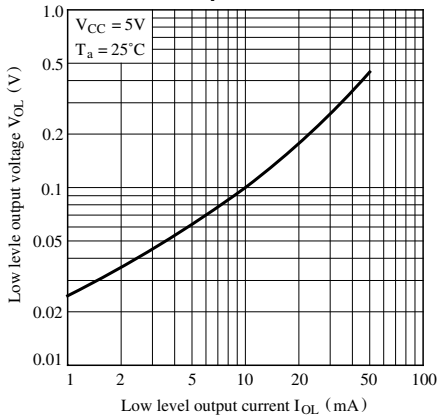


Fig. 8 Low Level Output Voltage vs. Ambient Temperature

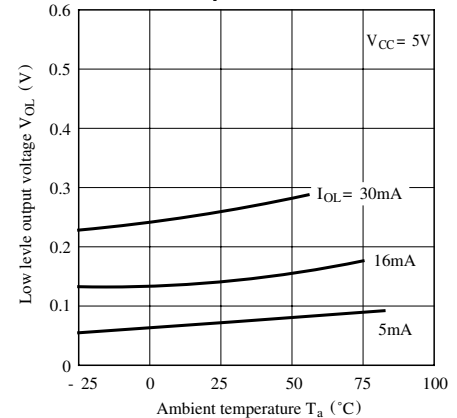


Fig. 9 Supply Current vs. Ambient Temperature

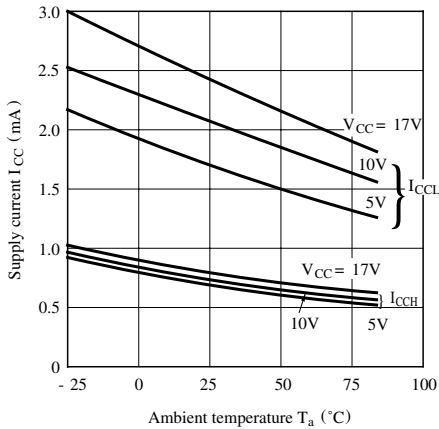


Fig.10 Propagation Delay Time vs. Forward Current

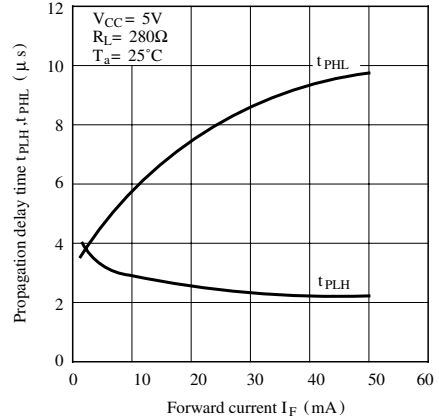
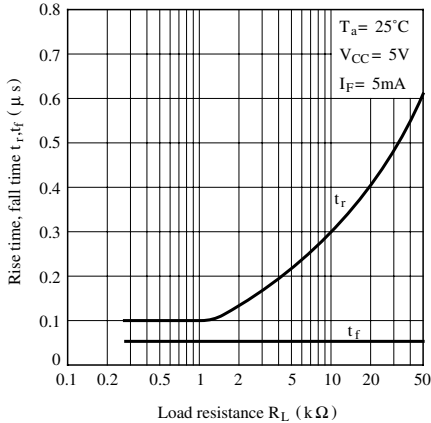
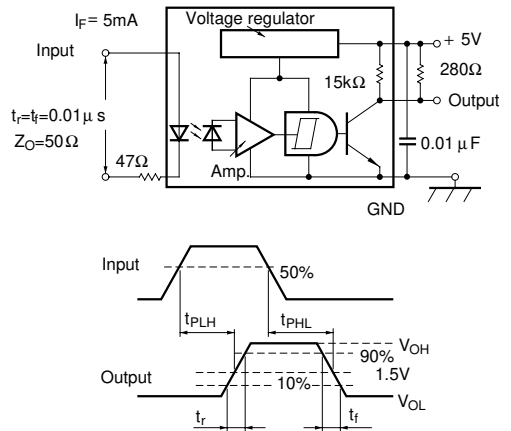


Fig.11 Rise Time, Fall Time vs. Load Resistance



Test Circuit for Response Time



■ Precautions for Use

- (1) In order to stabilize power supply line, connect a by-pass capacitor of more than 0.01µF between Vcc and GND near the device.
- (2) In case of cleaning, use only the following type of cleaning solvent.
Ethyl alcohol, Methyl alcohol, Isopropyl alcohol
- (3) As for other general cautions, refer to the chapter “Precautions for Use”.

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 - Consumer electronics
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 - Alarm equipment
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